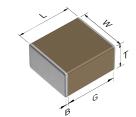


Multilayer Ceramic Chip Capacitors

CGA9P1X7T2J474M250KE

Product Status	Production		
TDK Item Description	CGA9P1X7T2J474MT***S		
Applications	Automotive Grade		
Feature	AEC-Q200AEC-Q200 MidMid Voltage (100 to 630V) SoftSoft Termination		
Series	CGA9(5750) [EIA 2220]		
Status	Production		
Brand	TDK		
Environmental Compliance	ROHS REACH Halogen Free Lead Free		



	Size
Length(L)	5.70mm +0.50,-0.40mm
Width(W)	5.00mm ±0.40mm
Thickness(T)	2.50mm ±0.30mm
Terminal Width(B)	0.20mm Min.
Recommended Land Pattern (PA)	4.10mm to 4.80mm
Recommended Land Pattern (PB)	1.20mm to 1.40mm
Recommended Land Pattern (PC)	4.00mm to 5.00mm

Electrical Characteristics		
Capacitance	470nF ±20%	
Rated Voltage	630VDC	
Temperature Characteristic	X7T(+22,-33%)	
Dissipation Factor (Max.)	2.5%	
Insulation Resistance (Min.)	1063ΜΩ	

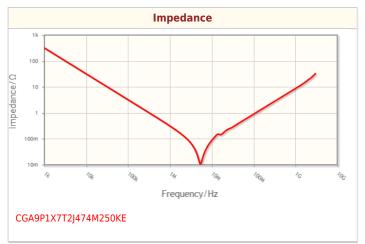
	Other
Operating Temp. Range	-55 to 125°C
Soldering Method	Reflow
AEC-Q200	YES
Packing	Embossed (Plastic)Taping [180mm Reel]
Package Quantity	500pcs

[!] Images are for reference only and show exemplary products.

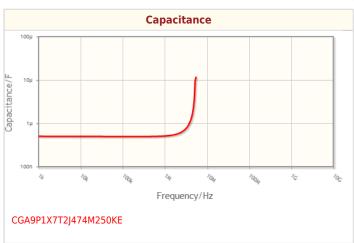
[!] This PDF document was created based on the data listed on the TDK Corporation website. ! All specifications are subject to change without notice.

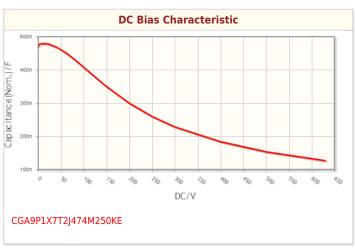
CGA9P1X7T2J474M250KE

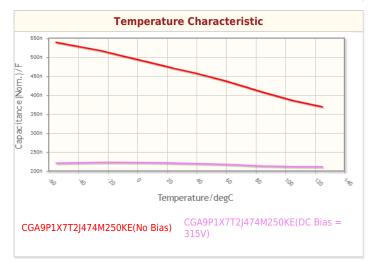
$Characteristic\ Graphs (This\ is\ reference\ data,\ and\ does\ not\ guarantee\ the\ products\ characteristics.)$

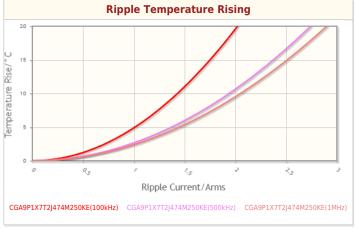












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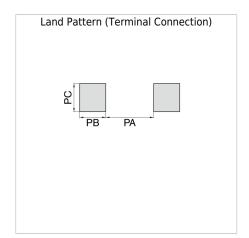
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Multilayer Ceramic Chip Capacitors

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Associated Images



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